



# Electronic Filing System (EFS) Data

## Electronic Patent Application Submission

### USPTO Use Only

EFS ID: 60087  
Application ID: 10643638   
Title of Invention: BOILING TEMPERATURE DESIGN  
IN PUMPED MICROCHANNEL  
COOLING LOOPS  
First Named Inventor: Peng Zhou  
Domestic/Foreign Application: Domestic Application  
Filing Date: 2003-08-18  
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Filing Type:  
Confirmation number: 4432  
Attorney Docket Number: NONE

**Total Fees Authorized:**

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**TRANSMITTAL**

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	BOILING TEMPERATURE DESIGN IN PUMPED MICROCHANNEL COOLING LOOPS	
Application Number:	10/643638	
Date:	2003-08-18	
First Named Applicant:	Peng Zhou	
Confirmation Number:	4432	
Attorney Docket Number:		
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Submitted by:	Elec. Sign.	Sign. Capacity
Thomas B. Haverstock Registered Number: 32571	/tbh/	Attorney
Documents being submitted	Files	
us-ids	COOL01500C-usidst.xml	
	us-ids.dtd	
	us-ids.xsl	
Comments		



## ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18  
Stylesheet Version v18.0

Title of Invention	BOILING TEMPERATURE DESIGN IN PUMPED MICROCHANNEL COOLING LOOPS						
Application Number:	10/643638 						
Confirmation Number:	4432						
First Named Applicant:	Peng Zhou						
Attorney Docket Number:							
Search string:	( 6068752 or 6090251 or 6096656 or 6100541 or 6101715 or 6119729 or 6126723 or 6129145 or 6129260 or 6131650 or 6146103 or 6154363 or 6159353 or 6171067 or 6174675 or 6176962 or 6186660 or 6210986 or 6216343 or 6221226 or 6227809 or 6234240 or 6238538 or 6277257 or 6287440 or 6301109 or 6313992 or 6317326 or 6321791 or 6322753 or 6324058 or 6351384 or 6337794 or 6388317 or 6396706 or 6400012 or 6406605 or 6415860 or 6416642 or 6417060 or 6424531 or 6443222 or 6444461 or 6457515 or 6495015 or 6537437 or 6543521 or 6553253 or 6572749 or 6588498 ).pn.						
<h3>US Patent Documents</h3>							
Note: Applicant is not required to submit a paper copy of cited US Patent Documents							
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
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Signature

Examiner Name	Date